

# Global Semiconductor Packaging Market Survey and Trend Research 2018

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## Abstracts

### SUMMARY

A semiconductor package is a metal, plastic, glass or ceramic casing containing one or more semiconductor electronic components.

This report describes the development of the industry by upstream & downstream, industry overall and development, key companies, as well as type segment & market application and so on, and makes a scientific prediction for the development industry prospects on the basis of analysis, finally, analyzes opportunities for investment in the industry at the end of the report.

### Industry Chain

Raw Materials

Cost

Technology

Consumer Preference

### Industry Overall:

History

## Development & Trend

Market Competition

Trade Overview

Policy

Region (North America, Europe, Asia-Pacific, South America, Middle East, Africa):

Regional Market

Production Development

Sales

Regional Trade

Regional Forecast

Company (ASE, Amkor, SPIL, Stats Chippac, JCET, JCET, J-Devices, UTAC, Chipmos, Chipbond, STS, Huatian, NFM, Carsem, Walton, Unisem, OSE, AOI, Formosa, NEPES. etc.):

Company Profile

Product & Service

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